

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

**In re Application of:**

James M. Derderian

**Serial No.:** 10/770,890

**Filed:** February 2, 2004

**For:** METHODS FOR FORMING  
ASSEMBLIES AND PACKAGES THAT  
INCLUDE STACKED SEMICONDUCTOR  
DEVICES SEPARATED A DISTANCE  
DEFINED BY ADHESIVE MATERIAL  
INTERPOSED THEREBETWEEN

**Confirmation No.:** 1094

**Examiner:** L. Thai

**Group Art Unit:** 2891

**Attorney Docket No.:** 2269-4817.3US  
(01-0103.03/US)

**Notice of Allowance Mailed:**

September 14, 2007

**VIA ELECTRONIC FILING**

**DECEMBER 12, 2007**

**AMENDMENT PURSUANT TO 37 C.F.R. § 1.312(a)**

Mail Stop ISSUE FEE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

Sir:

Please amend the above-referenced application as follows:

**Amendments to the specification** appear on page 3 of this paper;  
**A listing of the claims** is set forth beginning on page 4 of this paper; and  
**Remarks** start at page 11 of this paper.